

MOSFET

OptiMOS[™] 5 Power-Transistor, 100 V

Features

- Ideal for high frequency switching and sync. rec.
- Excellent gate charge x R_{DS(on)} product (FOM)
 Very low on-resistance R_{DS(on)}
 N-channel, normal level

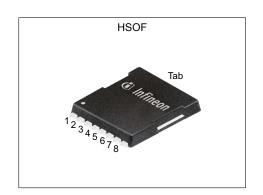
- 100% avalanche tested
- Pb-free plating; RoHS compliant
 Halogen-free according to IEC61249-2-21

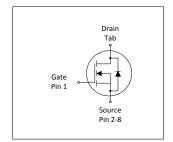
Product validation

Fully qualified according to JEDEC for Industrial Applications

Table 1 **Kev Performance Parameters**

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Parameter	Value	Unit						
V _{DS}	100	V						
R _{DS(on),max}	2.6	mΩ						
I_{D}	202	A						
Qoss	123	nC						
Q _G (0V10V)	96	nC						











Type / Ordering Code	Package	Marking	Related Links
IPT026N10N5	PG-HSOF-8	026N10N5	-

OptiMOS[™] 5 Power-Transistor, 100 V IPT026N10N5



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OptiMOS[™] 5 Power-Transistor, 100 V . IPT026N10N5



1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 **Maximum ratings**

Danamatan	Symbol	Values				N
Parameter		Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current	I _D			202 143 27	A	$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =10 V, $T_{\rm A}$ =25 °C, $R_{\rm THJA}$ =40 °C/W ¹)
Pulsed drain current ²⁾	I _{D,pulse}	-	-	808	Α	<i>T</i> _A =25 °C
Avalanche energy, single pulse ³⁾	E AS	-	-	250	mJ	$I_{\rm D}$ =150 A, $R_{\rm GS}$ =25 Ω
Gate source voltage	V _{GS}	-20	-	20	-	-
Power dissipation	P _{tot}	-	-	214	W	<i>T</i> _C =25 °C
Operating and storage temperature	T _j , T _{stg}	-55	-	175	°C	IEC climatic category; DIN IEC 68-1 55/175/56

2 Thermal characteristics

Thermal characteristics Table 3

Parameter	Symbol	Values			Unit	Note / Test Condition
Parameter	Symbol	Min.	Тур.	Max.	Ullit	Note / Test Condition
Thermal resistance, junction - case	R _{thJC}	-	0.4	0.7	°C/W	-
Device on PCB, minimal footprint	R_{thJA}	-	-	62	°C/W	-
Device on PCB, 6 cm² cooling area ¹⁾	R _{thJA}	-	-	40	°C/W	-

 $^{^{1)}}$ Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 µm thick) copper area for drain connection. PCB is vertical in still air. $^{2)}$ See Diagram 3 for more detailed information $^{3)}$ See Diagram 13 for more detailed information

OptiMOS[™] 5 Power-Transistor, 100 V . IPT026N10N5



Electrical characteristics

at T_j=25 °C, unless otherwise specified

Table 4 **Static characteristics**

Danamatan	0	Values				
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V _{(BR)DSS}	100	-	-	V	V _{GS} =0 V, I _D =1 mA
Gate threshold voltage	$V_{\rm GS(th)}$	2.2	3.0	3.8	V	$V_{\rm DS} = V_{\rm GS}, I_{\rm D} = 158 \ \mu {\rm A}$
Zero gate voltage drain current	I _{DSS}	-	0.1 10	5 100	μA	V _{DS} =100 V, V _{GS} =0 V, T _j =25 °C V _{DS} =100 V, V _{GS} =0 V, T _j =125 °C
Gate-source leakage current	I _{GSS}	-	10	100	nA	V _{GS} =20 V, V _{DS} =0 V
Drain-source on-state resistance	R _{DS(on)}	-	2.2 2.7	2.6 3.5	mΩ	V _{GS} =10 V, I _D =150 A V _{GS} =6 V, I _D =75 A
Gate resistance ¹⁾	R _G	-	1.3	1.95	Ω	-
Transconductance	g fs	105	210	-	S	$ V_{DS} \ge 2 I_D R_{DS(on)max}, I_D = 100 \text{ A}$

Table 5 **Dynamic characteristics**

Parameter	Symbol	Values			11	Nata / Tank Oam distant
Parameter		Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance ¹⁾	Ciss	-	6800	8800	pF	V _{GS} =0 V, V _{DS} =50 V, <i>f</i> =1 MHz
Output capacitance ¹⁾	Coss	-	1000	1300	pF	V _{GS} =0 V, V _{DS} =50 V, <i>f</i> =1 MHz
Reverse transfer capacitance ¹⁾	C _{rss}	-	46	80	pF	V _{GS} =0 V, V _{DS} =50 V, f=1 MHz
Turn-on delay time	$t_{\rm d(on)}$	-	17	-	ns	$V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =100 A, $R_{\rm G,ext}$ =1.8 Ω
Rise time	t _r	-	11	-	ns	$V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =100 A, $R_{\rm G,ext}$ =1.8 Ω
Turn-off delay time	$t_{ m d(off)}$	-	38	-	ns	$V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =100 A, $R_{\rm G,ext}$ =1.8 Ω
Fall time	t _f	-	13	-	ns	$V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =100 A, $R_{\rm G,ext}$ =1.8 Ω

Gate charge characteristics²⁾ Table 6

Parameter	Symbol		Values			Note / Took Condition
Parameter		Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q _{gs}	-	32	-	nC	$V_{\rm DD}$ =50 V, $I_{\rm D}$ =100 A, $V_{\rm GS}$ =0 to 10 V
Gate charge at threshold	Q _{g(th)}	-	20	-	nC	$V_{\rm DD}$ =50 V, $I_{\rm D}$ =100 A, $V_{\rm GS}$ =0 to 10 V
Gate to drain charge ¹⁾	Q _{gd}	-	20	30	nC	$V_{\rm DD}$ =50 V, $I_{\rm D}$ =100 A, $V_{\rm GS}$ =0 to 10 V
Switching charge	Q _{sw}	-	31	-	nC	$V_{\rm DD}$ =50 V, $I_{\rm D}$ =100 A, $V_{\rm GS}$ =0 to 10 V
Gate charge total ¹⁾	Q g	-	96	120	nC	$V_{\rm DD}$ =50 V, $I_{\rm D}$ =100 A, $V_{\rm GS}$ =0 to 10 V
Gate plateau voltage	V _{plateau}	-	4.7	-	V	$V_{\rm DD}$ =50 V, $I_{\rm D}$ =100 A, $V_{\rm GS}$ =0 to 10 V
Gate charge total, sync. FET	Q _{g(sync)}	-	83	-	nC	V _{DS} =0.1 V, V _{GS} =0 to 10 V
Output charge ¹⁾	Qoss	-	123	164	nC	V _{DS} =50 V, V _{GS} =0 V

 $^{^{1)}}$ Defined by design. Not subject to production test. $^{2)}$ See "Gate charge waveforms" for parameter definition

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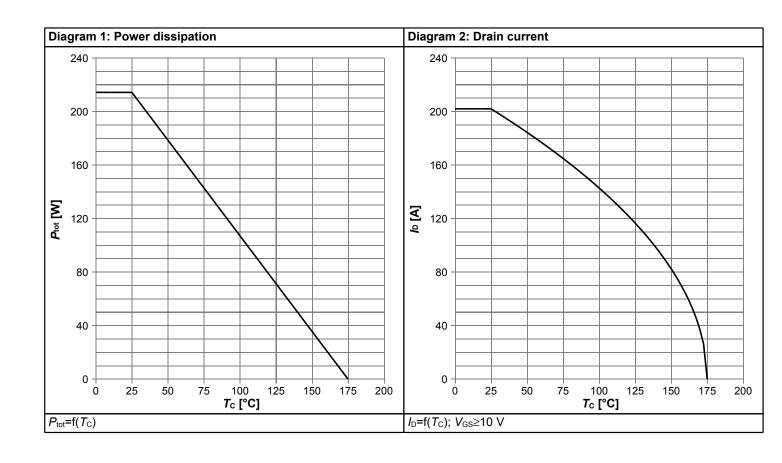


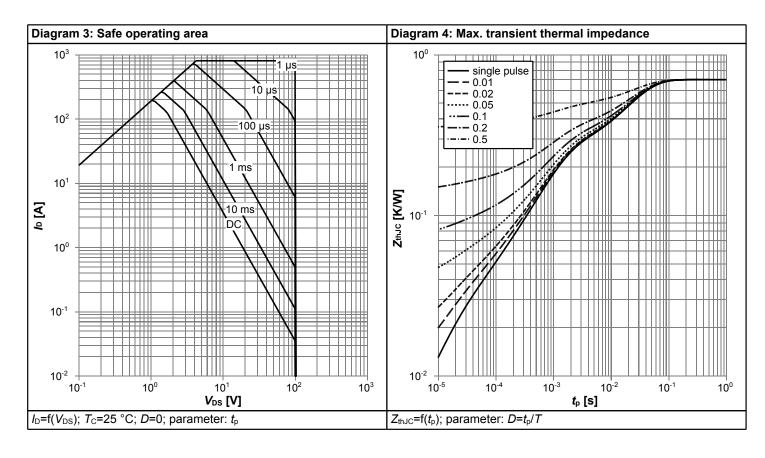
Table 7 Reverse diode

Davamatan	Complete	Values			11	Note / Took Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Diode continuous forward current	Is	-	-	159	Α	T _C =25 °C	
Diode pulse current	I _{S,pulse}	-	-	808	Α	<i>T</i> _C =25 °C	
Diode forward voltage	V _{SD}	-	0.89	1.2	V	V _{GS} =0 V, I _F =100 A, T _j =25 °C	
Reverse recovery time ¹⁾	t _{rr}	-	40	80	ns	V _R =50 V, I _F =100 A, di _F /dt=100 A/μs	
Reverse recovery charge ¹⁾	Qrr	-	52	104	nC	V _R =50 V, I _F =100 A, d <i>i</i> _F /d <i>t</i> =100 A/μs	

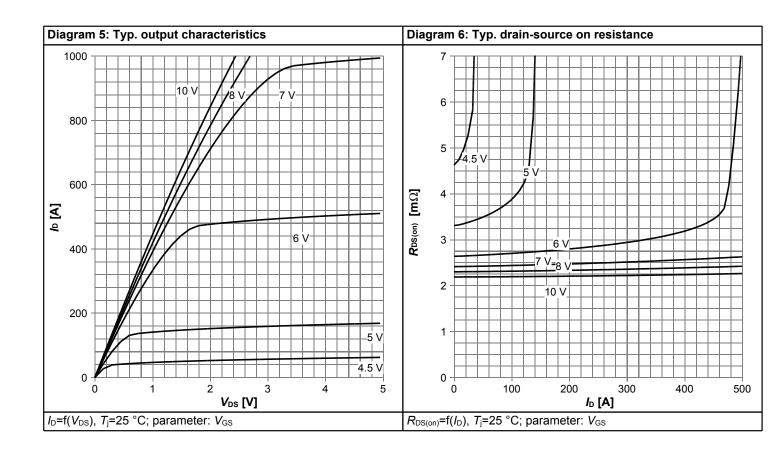


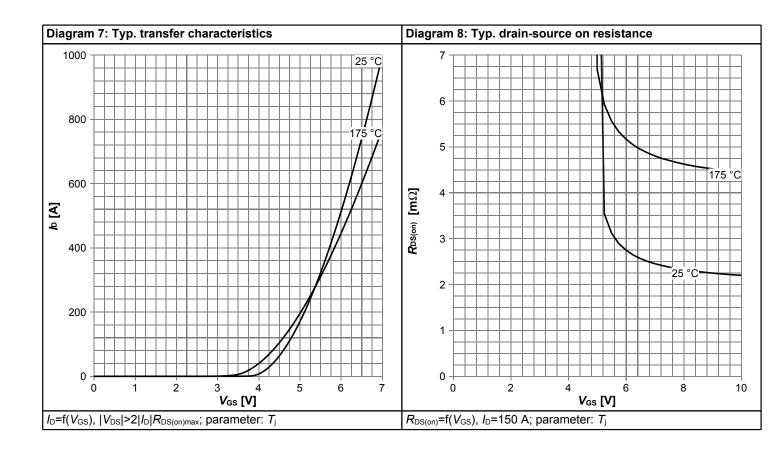
4 Electrical characteristics diagrams



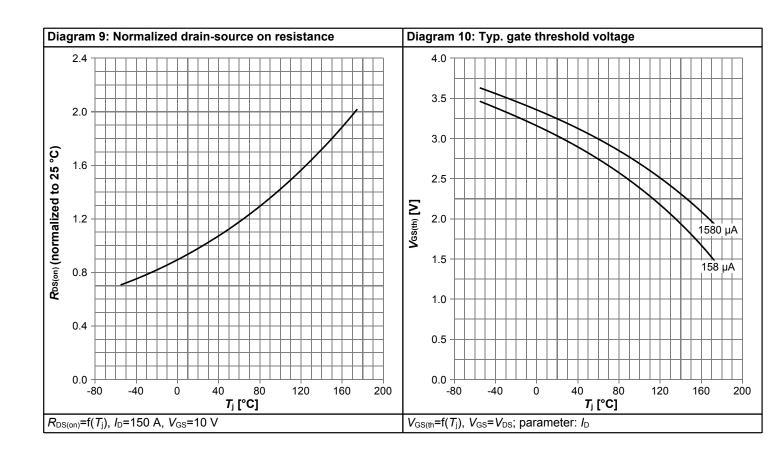


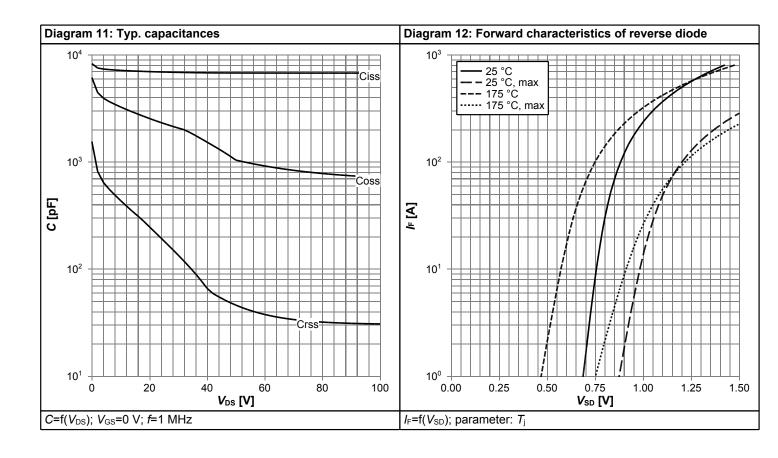




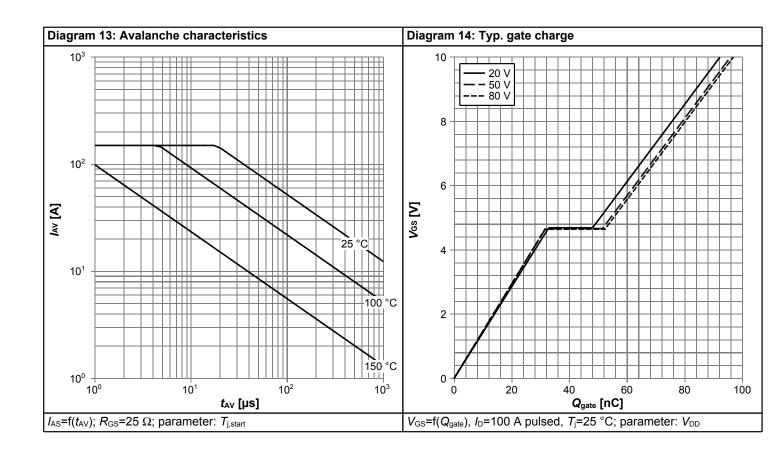


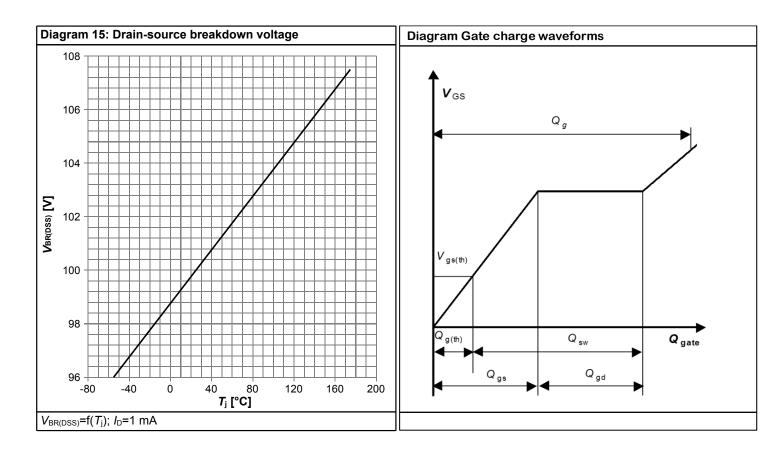














5 Package Outlines

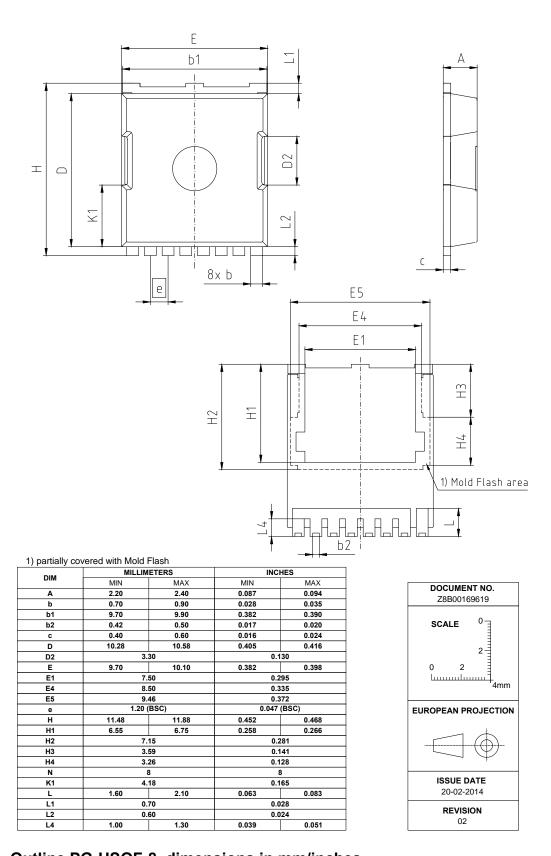


Figure 1 Outline PG-HSOF-8, dimensions in mm/inches

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Revision History

IPT026N10N5

Revision: 2019-03-28, Rev. 2.1

Previous Revision

Torrodo Novision							
Revision	Date	Subjects (major changes since last revision)					
2.0	2019-02-21	Release of final version					
2.1	2019-03-28	Addition max values					

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